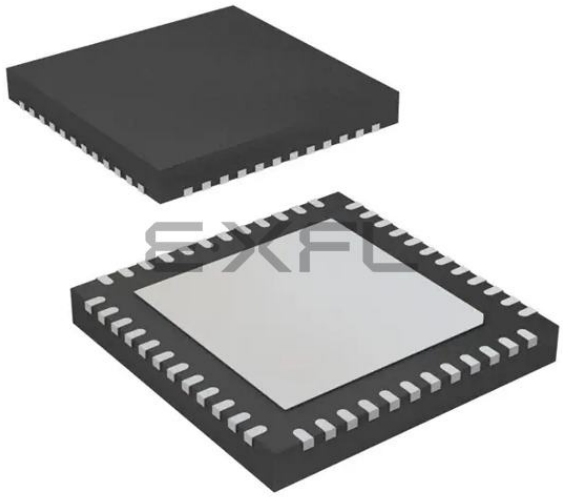

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	44
Program Memory Size	64KB (32K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 43x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-UFQFN Exposed Pad
Supplier Device Package	48-UQFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf56k42-e-mv

REGISTER 5-7: CONFIGURATION WORD 4L (30 0006h)

R/W-1	U-1	U-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
$\overline{\text{WRTAPP}}$ (1)	—	—	$\overline{\text{SAFEN}}$ (1)	$\overline{\text{BBEN}}$ (1)	BBSIZE<2:0> (2)		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '1'	
-n = Value for blank device	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **$\overline{\text{WRTAPP}}$:** Application Block Write Protection bit(1)
1 = Application Block is NOT write-protected
0 = Application Block is write-protected

bit 6-5 **Unimplemented:** Read as '1'

bit 4 **$\overline{\text{SAFEN}}$:** Storage Area Flash Enable bit(1)
1 = SAF is disabled
0 = SAF is enabled

bit 3 **$\overline{\text{BBEN}}$:** Boot Block Enable bit(1)
1 = Boot Block disabled
0 = Boot Block enabled

bit 2-0 **BBSIZE<2:0>:** Boot Block Size Selection bits(2)
Refer to Table 5-1.

Note 1: Bits are implemented as sticky bits. Once protection is enabled through ICSP™ or a self-write, it can only be reset through a Bulk Erase.
2: BBSIZE<2:0> bits can only be changed when $\overline{\text{BBEN}}$ = 1. Once $\overline{\text{BBEN}}$ = 0, BBSIZE<2:0> can only be changed through a Bulk Erase.

TABLE 5-1: BOOT BLOCK SIZE BITS

$\overline{\text{BBEN}}$	BBSIZE<2:0>	Boot Block Size (words)	END_ADDRESS_BOOT	Device Size(1)		
				16k	32k	64k
1	xxx	0	—	X	X	X
0	111	512	00 03FFh	X	X	X
0	110	1024	00 07FFh	X	X	X
0	101	2048	00 0FFFh	X	X	X
0	100	4096	00 1FFFh	X	X	X
0	011	8192	00 3FFFh	X	X	X
0	010	16384	00 7FFFh	—	X	X
0	001	32768	00 FFFFh		Note 2	X
0	000	32768	00 FFFFh	—	—	—

Note 1: For each device, the quoted device size specification is listed in Table 4-1.
2: The maximum boot block size is half the user program memory size. All selections higher than the maximum size default to maximum boot block size of half PFM. For example, all settings of BBSIZE = 000 through BBSIZE = 010, default to a boot block size of 16 kW on a 32 kW device.

REGISTER 5-8: CONFIGURATION WORD 4H (30 0007h)

U-1	U-1	R/W-1	U-1	R/W-1	R/W-1	R/W-1	R/W-1
—	—	LVP(2)	—	$\overline{\text{WRTSAF}}$ (1,3)	$\overline{\text{WRTD}}$ (1,4)	$\overline{\text{WRTC}}$ (1)	$\overline{\text{WRTB}}$(1,5)
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '1'	
-n = Value for blank device	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented:** Read as '1'

bit 5 **LVP:** Low-Voltage Programming Enable bit(2)
1 = Low-voltage programming enabled. $\overline{\text{MCLR}}$/VPP pin function is $\overline{\text{MCLR}}$. MCLRE (Register 5-3) is ignored.
0 = HV on $\overline{\text{MCLR}}$/VPP must be used for programming.

bit 4 **Unimplemented:** Read as '1'

bit 3 **$\overline{\text{WRTSAF}}$:** Storage Area Flash (SAF) Write Protection bit(1,3)
1 = SAF is NOT write-protected
0 = SAF is write-protected

bit 2 **$\overline{\text{WRTD}}$:** Data EEPROM Write Protection bit(1,4)
1 = Data EEPROM NOT write-protected
0 = Data EEPROM write-protected

bit 1 **$\overline{\text{WRTC}}$:** Configuration Register Write Protection bit(1)
1 = Configuration Register NOT write-protected
0 = Configuration Register write-protected

bit 0 **$\overline{\text{WRTB}}$:** Boot Block Write Protection bit(1,5)
1 = Boot Block NOT write-protected
0 = Boot Block write-protected

Note 1: Bits are implemented as sticky bits. Once protection is enabled through ICSP or a self write, it can only be reset through a Bulk Erase.

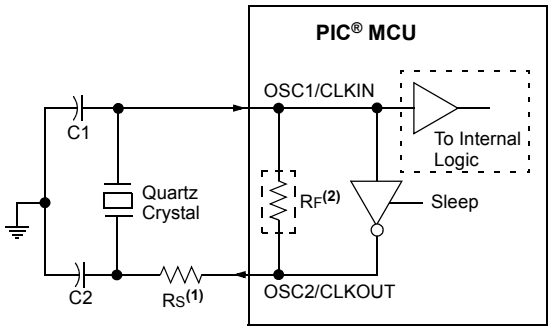
2: The LVP bit cannot be written (to zero) while operating from the LVP programming interface. The purpose of this rule is to prevent the user from dropping out of LVP mode while programming from LVP mode, or accidentally eliminating LVP mode from the configuration state.

3: Unimplemented if SAF is not present and only applicable if $\overline{\text{SAFEN}}$ = 0.

4: Unimplemented if data EEPROM is not present.

5: Only applicable if $\overline{\text{BBEN}}$ = 0.

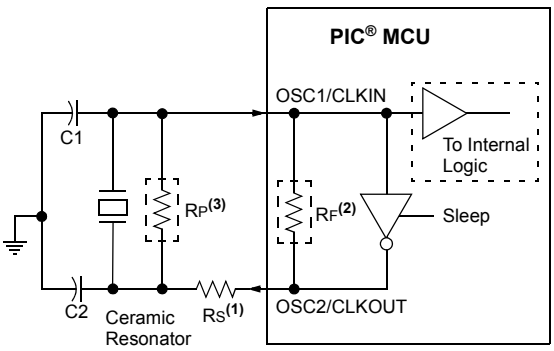
FIGURE 7-3: QUARTZ CRYSTAL OPERATION (LP, XT OR HS MODE)



Note 1: A series resistor (RS) may be required for quartz crystals with low drive level.

2: The value of RF varies with the Oscillator mode selected (typically between 2 MΩ to 10 MΩ).

FIGURE 7-4: CERAMIC RESONATOR OPERATION (XT OR HS MODE)



Note 1: A series resistor (RS) may be required for ceramic resonators with low drive level.

2: The value of RF varies with the Oscillator mode selected (typically between 2 MΩ to 10 MΩ).

3: An additional parallel feedback resistor (RP) may be required for proper ceramic resonator operation.

7.2.1.3 Oscillator Start-up Timer (OST)

If the oscillator module is configured for LP, XT or HS modes, the Oscillator Start-up Timer (OST) counts 1024 oscillations from OSC1. This occurs following a Power-on Reset (POR), or a wake-up from Sleep. The OST ensures that the oscillator circuit, using a quartz crystal resonator or ceramic resonator, has started and is providing a stable system clock to the oscillator module.

7.2.1.4 4x PLL

The oscillator module contains a 4x PLL that can be used with the external clock sources to provide a system clock source. The input frequency for the PLL must fall within specifications. See the PLL Clock Timing Specifications in Table 44-11.

The PLL can be enabled for use by one of two methods:

1. Program the RSTOSC bits in the Configuration Word 1 to 010 (enable EXTOSC with 4x PLL).
2. Write the NOSC bits in the OSCCON1 register to 010 (enable EXTOSC with 4x PLL).

9.6 Returning from Interrupt Service Routine (ISR)

The “Return from Interrupt” instruction (`RETFIE`) is used to mark the end of an ISR.

When `RETFIE 1` instruction is executed, the PC is loaded with the saved PC value from the top of the PC stack. Saved context is also restored with the execution of this instruction. Thus, execution returns to the previous state of operation that existed before the interrupt occurred.

When `RETFIE 0` instruction is executed, the saved context is not restored back to the registers.

9.7 Interrupt Latency

By assigning each interrupt with a vector address/ number (MVECEN = `1`), scanning of all interrupts is not necessary to determine the source of the interrupt.

When MVECEN = `1`, Vectored interrupt controller requires three clock cycles to vector to the ISR from main routine, thereby removing dependency of interrupt timing on compiled code.

There is a fixed latency of three instruction cycles between the completion of the instruction active when the interrupt occurred and the first instruction of the Interrupt Service Routine. Figure 9-7, Figure 9-8 and Figure 9-9 illustrate the sequence of events when a peripheral interrupt is asserted when the last executed instruction is one-cycle, two-cycle and three-cycle respectively, when MVECEN = `1`.

After the Interrupt Flag Status bit is set, the current instruction completes executing. In the first latency cycle, the contents of the PC, STATUS, WREG, BSR, FSR0/1/2, PRODL/H and PCLATH/U registers are context saved and the IVTBASE+ Vector number is calculated. In the second latency cycle, the PC is loaded with the calculated vector table address for the interrupt source and the starting address of the ISR is fetched. In the third latency cycle, the PC is loaded with the ISR address. All the latency cycles are executed as a `FNOP` instruction.

When MVECEN = `0`, Vectored interrupt controller requires two clock cycles to vector to the ISR from main routine. There is a latency of two instruction cycles plus the software latency between the completion of the instruction active when the interrupt occurred and the first instruction of the Interrupt Service Routine.

REGISTER 9-42: IVTLOCK: INTERRUPT VECTOR TABLE LOCK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0
—	—	—	—	—	—	—	IVTLOCKED(1,2)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-1 **Unimplemented:** Read as '0'

bit 0 **IVTLOCKED**: IVT Registers Lock bits(1,2)

1 = IVTBASE Registers are locked and cannot be written
0 = IVTBASE Registers can be modified by write operations

Note 1: The IVTLOCK bit can only be set or cleared after the unlock sequence in Example 9-1.
2: If IVT1WAY = 1, the IVTLOCK bit cannot be cleared after it has been set. See Register 5-3.

REGISTER 9-43: SHADCON: SHADOW CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0
—	—	—	—	—	—	—	SHADLO
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-1 **Unimplemented:** Read as '0'

bit 0 **SHADLO:** Interrupt Shadow Register Access Switch bit

0 = Access Main Context for Interrupt Shadow Registers
1 = Access Low-Priority Interrupt Context for Interrupt Shadow Registers

REGISTER 19-4: PMD3: PMD CONTROL REGISTER 3

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
PWM8MD	PWM7MD	PWM6MD	PWM5MD	CCP4MD	CCP3MD	CCP2MD	CCP1MD
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **PWM8MD:** Disable Pulse-Width Modulator PWM8 bit
1 = PWM8 module disabled
0 = PWM8 module enabled

bit 6 **PWM7MD:** Disable Pulse-Width Modulator PWM7 bit
1 = PWM7 module disabled
0 = PWM7 module enabled

bit 5 **PWM6MD:** Disable Pulse-Width Modulator PWM6 bit
1 = PWM6 module disabled
0 = PWM6 module enabled

bit 4 **PWM5MD:** Disable Pulse-Width Modulator PWM5 bit
1 = PWM5 module disabled
0 = PWM5 module enabled

bit 3 **CCP4MD:** Disable Capture/Compare/PWM CCP4 bit
1 = CCP4 module disabled
0 = CCP4 module enabled

bit 2 **CCP3MD:** Disable Capture/Compare/PWM CCP3 bit
1 = CCP3 module disabled
0 = CCP3 module enabled

bit 1 **CCP2MD:** Disable Capture/Compare/PWM CCP2 bit
1 = CCP2 module disabled
0 = CCP2 module enabled

bit 0 **CCP1MD:** Disable Capture/Compare/PWM CCP1 bit
1 = CCP1 module disabled
0 = CCP1 module enabled

REGISTER 20-2: T0CON1: TIMER0 CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
CS<2:0>			ASYNC	CKPS<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-5 **CS<2:0>:** Timer0 Clock Source Select bits
111 = CLC1
110 = SOSC
101 = MFINTOSC (500 kHz)
100 = LFINTOSC
011 = HFINTOSC
010 = FOSC/4
001 = Pin selected by T0CKIPPS (Inverted)
000 = Pin selected by T0CKIPPS (Non-inverted)

bit 4 **ASYNC:** TMR0 Input Asynchronization Enable bit
1 = The input to the TMR0 counter is not synchronized to system clocks
0 = The input to the TMR0 counter is synchronized to FOSC/4

bit 3-0 **CKPS<3:0>:** Prescaler Rate Select bit
1111 = 1:32768
1110 = 1:16384
1101 = 1:8192
1100 = 1:4096
1011 = 1:2048
1010 = 1:1024
1001 = 1:512
1000 = 1:256
0111 = 1:128
0110 = 1:64
0101 = 1:32
0100 = 1:16
0011 = 1:8
0010 = 1:4
0001 = 1:2
0000 = 1:1

FIGURE 21-5: TIMER1/3/5 GATE TOGGLE MODE

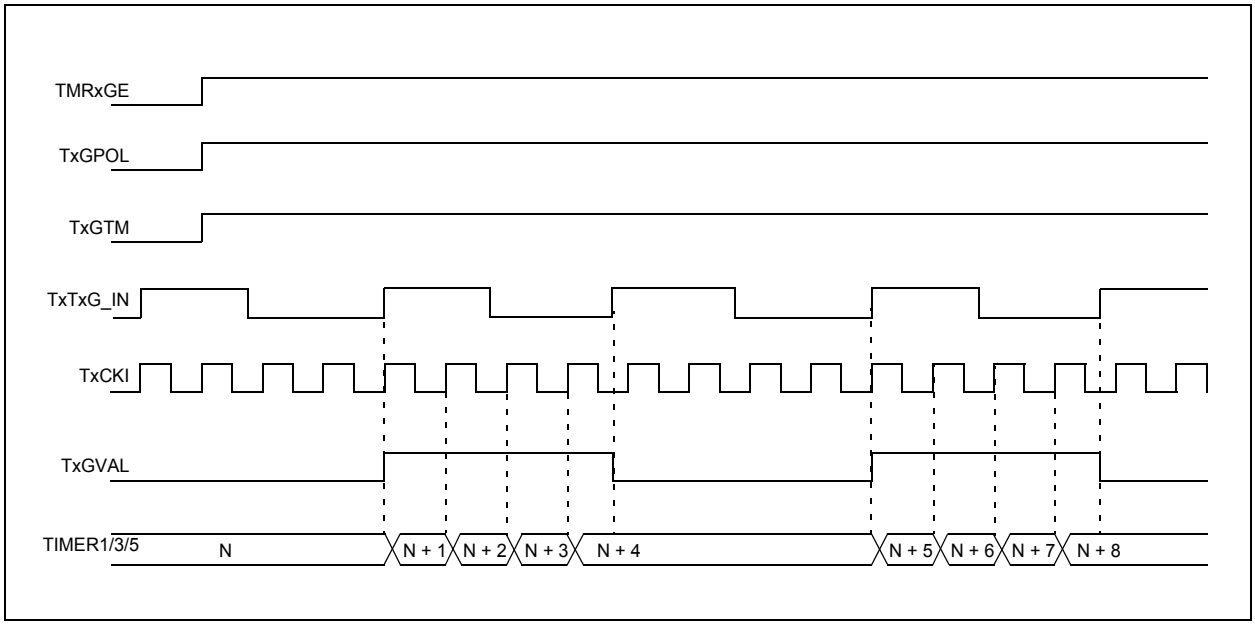
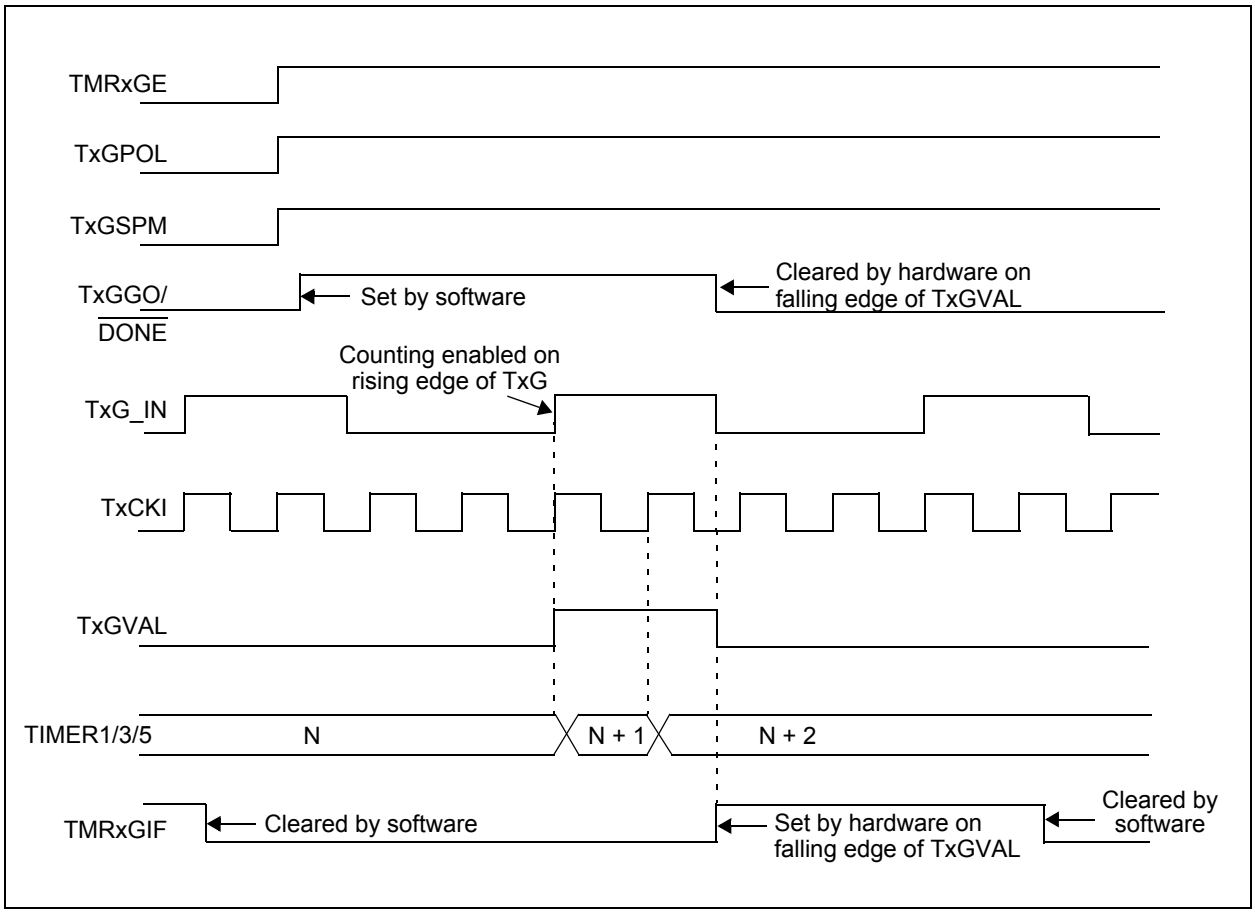


FIGURE 21-6: TIMER1/3/5 GATE SINGLE-PULSE MODE



25.6.11 WINDOWED COUNTER MODE

This mode counts pulses on the SMT1_signal input, within a window dictated by the SMT1WIN input. It begins counting upon seeing a rising edge of the SMT1WIN input, updates the SMT1CPW register on a falling edge of the SMT1WIN input, and updates the SMT1CPR register on each rising edge of the SMT1WIN input beyond the first. See Figure 25-21 and Figure 25-22.

26.2.3.1 Direction Change in Full-Bridge Mode

In Full-Bridge mode, changing MODE<2:0> controls the forward/reverse direction. Changes to MODE<2:0> change to the new direction on the next rising edge of the modulated input.

A direction change is initiated in software by changing the MODE<2:0> bits of the CWGxCON0 register. The sequence is illustrated in Figure 26-8.

- The associated active output CWGxA and the inactive output CWGxC are switched to drive in the opposite direction.
- The previously modulated output CWGxD is switched to the inactive state, and the previously inactive output CWGxB begins to modulate.
- CWG modulation resumes after the direction-switch dead band has elapsed.

26.2.3.2 Dead-Band Delay in Full-Bridge Mode

Dead-band delay is important when either of the following conditions is true:

1. The direction of the CWG output changes when the duty cycle of the data input is at or near 100%, or
2. The turn-off time of the power switch, including the power device and driver circuit, is greater than the turn-on time.

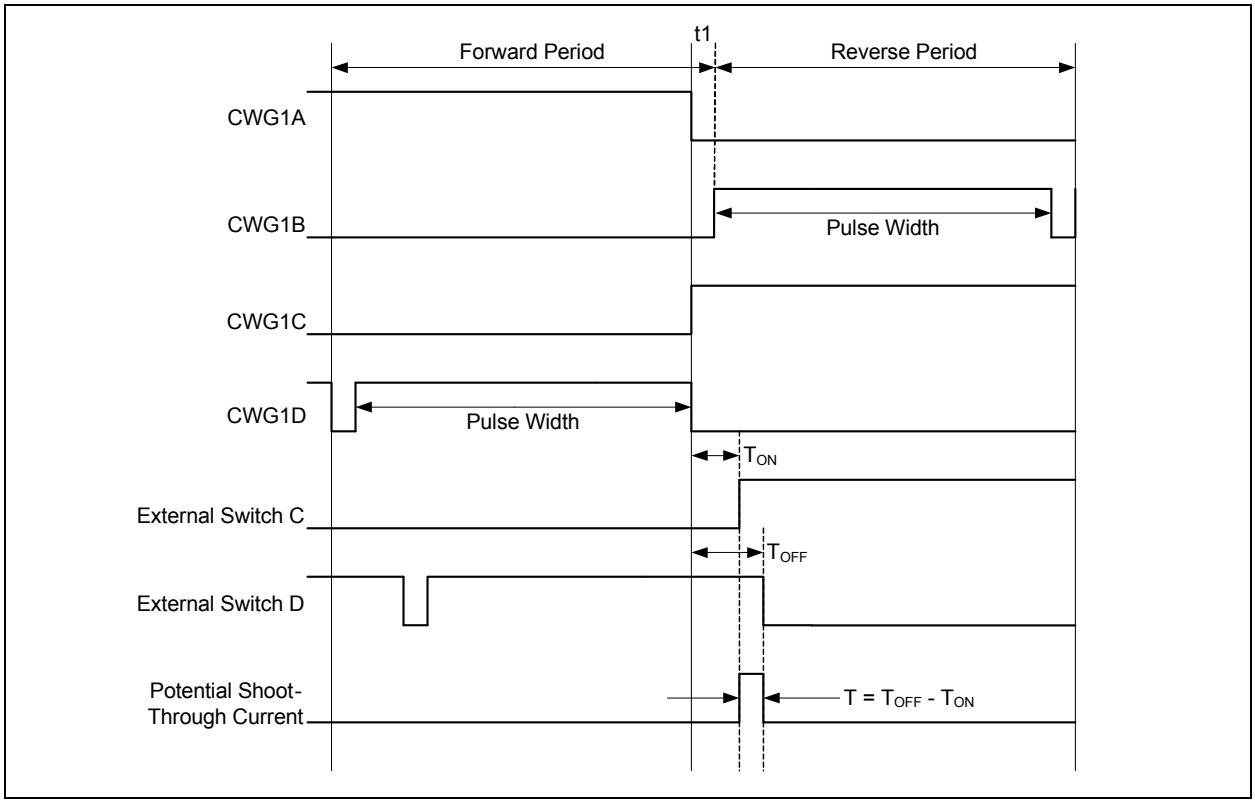
The dead-band delay is inserted only when changing directions, and only the modulated output is affected. The statically-configured outputs (CWGxA and CWGxC) are not afforded dead band, and switch essentially simultaneously.

Figure 26-8 shows an example of the CWG outputs changing directions from forward to reverse, at near 100% duty cycle. In this example, at time t1, the output of CWGxA and CWGxD become inactive, while output CWGxC becomes active. Since the turn-off time of the power devices is longer than the turn-on time, a shoot-through current will flow through power devices QC and QD for the duration of 't'. The same phenomenon will occur to power devices QA and QB for the CWG direction change from reverse to forward.

When changing the CWG direction at high duty cycle is required for an application, two possible solutions for eliminating the shoot-through current are:

1. Reduce the CWG duty cycle for one period before changing directions.
2. Use switch drivers that can drive the switches off faster than they can drive them on.

FIGURE 26-8: EXAMPLE OF PWM DIRECTION CHANGE AT NEAR 100% DUTY CYCLE



26.3 Clock Source

The clock source is used to drive the dead-band timing circuits. The CWG module allows the following clock sources to be selected:

- FOSC (system clock)
- HFINTOSC

When the HFINTOSC is selected, the HFINTOSC will be kept running during Sleep. Therefore, CWG modes requiring dead band can operate in Sleep, provided that the CWG data input is also active during Sleep.The clock sources are selected using the CS bit of the CWGxCLKCON register (Register 26-3). The system clock FOSC, is disabled in Sleep and thus dead-band control cannot be used.

26.4 Selectable Input Sources

The CWG generates the output waveforms from the following input sources:

TABLE 26-1: SELECTABLE INPUT SOURCES

Source Peripheral	Signal Name	ISM<2:0>
CWGxPPS	Pin selected by CWGxPPS	000
CCP1	CCP1 Output	001
CCP2	CCP2 Output	010
PWM3	PWM3 Output	011
PWM4	PWM4 Output	100
CMP1	Comparator 1 Output	101
CMP2	Comparator 2 Output	110
DSM	Data signal modulator output	111

The input sources are selected using the IS<4:0> bits in the CWGxISM register (Register 26-4).

26.5 Output Control

26.5.1 CWG OUTPUTS

Each CWG output can be routed to a Peripheral Pin Select (PPS) output via the RxyPPS register (see **Section 17.0 "Peripheral Pin Select (PPS) Module"**).

26.5.2 POLARITY CONTROL

The polarity of each CWG output can be selected independently. When the output polarity bit is set, the corresponding output is active-high. Clearing the output polarity bit configures the corresponding output as active-low. However, polarity does not affect the override levels. Output polarity is selected with the POLy bits of the CWGxCON1. Auto-shutdown and steering options are unaffected by polarity.

26.6 Dead-Band Control

The dead-band control provides non-overlapping PWM signals to prevent shoot-through current in PWM switches. Dead-band operation is employed for Half-Bridge and Full-Bridge modes. The CWG contains two 6-bit dead-band counters. One is used for the rising edge of the input source control in Half-Bridge mode or for reverse dead-band Full-Bridge mode. The other is used for the falling edge of the input source control in Half-Bridge mode or for forward dead band in Full-Bridge mode.

Dead band is timed by counting CWG clock periods from zero up to the value in the rising or falling dead-band counter registers. See CWGxDBR and CWGxDBF registers, respectively.

26.6.1 DEAD-BAND FUNCTIONALITY IN HALF-BRIDGE MODE

In Half-Bridge mode, the dead-band counters dictate the delay between the falling edge of the normal output and the rising edge of the inverted output. This can be seen in Figure 26-2.

26.6.2 DEAD-BAND FUNCTIONALITY IN FULL-BRIDGE MODE

In Full-Bridge mode, the dead-band counters are used when undergoing a direction change. The MODE<0> bit of the CWGxCON0 register can be set or cleared while the CWG is running, allowing for changes from Forward to Reverse mode. The CWGxA and CWGxC signals will change immediately upon the first rising input edge following a direction change, but the modulated signals (CWGxB or CWGxD, depending on the direction of the change) will experience a delay dictated by the dead-band counters.

30.11 Register Definitions: Modulation Control

Long bit name prefixes for the Modulation peripheral is shown below. Refer to **Section 1.3.2.2 "Long Bit Names"** for more information.

Peripheral	Bit Name Prefix
MD1	MD1

REGISTER 30-1: MD1CON0: MODULATION CONTROL REGISTER 0

R/W-0/0	U-0	R-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
EN	—	OUT	OPOL	—	—	—	BIT
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **EN:** Modulator Module Enable bit
1 = Modulator module is enabled and mixing input signals
0 = Modulator module is disabled and has no output

bit 6 **Unimplemented:** Read as '0'

bit 5 **OUT:** Modulator Output bit
Displays the current output value of the Modulator module.(1)

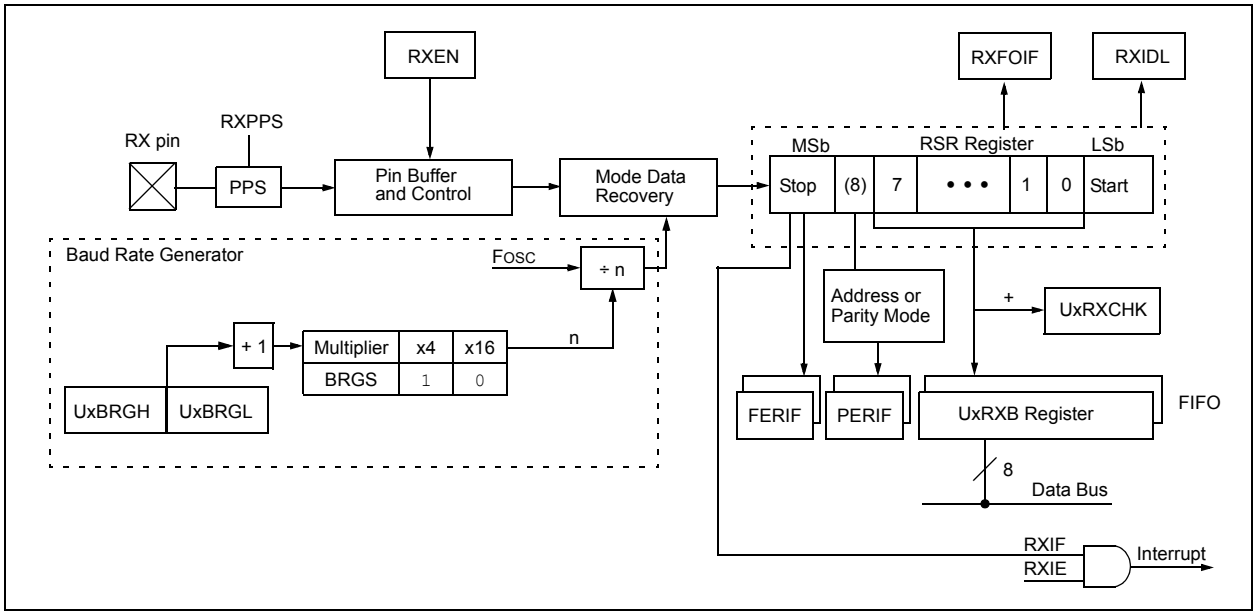
bit 4 **OPOL:** Modulator Output Polarity Select bit
1 = Modulator output signal is inverted; idle high output
0 = Modulator output signal is not inverted; idle low output

bit 3-1 **Unimplemented:** Read as '0'

bit 0 **BIT:** Allows software to manually set modulation source input to module(2)
1 = Modulator selects Carrier High
0 = Modulator selects Carrier Low

Note 1: The modulated output frequency can be greater and asynchronous from the clock that updates this register bit, the bit value may not be valid for higher speed modulator or carrier signals.
2: BIT bit must be selected as the modulation source in the MD1SRC register for this operation.

FIGURE 31-2: UART RECEIVE BLOCK DIAGRAM



The operation of the UART module is controlled through nineteen registers:

- Three control registers (UxCON0-UxCON2)
- Error enable and status (UxERRIE, UxERRIR, UxUIR)
- UART buffer status and control (UxFIFO)
- Three 9-bit protocol parameters (UxP1-UxP3)
- 16-bit baud rate generator (UxBRGH:L)
- Transmit buffer write (UxTXB)
- Receive buffer read (UxRXB)
- Receive checksum (UxRXCHK)
- Transmit checksum (UxTXCHK)

These registers are detailed in **Section 31.21 "Register Definitions: UART Control"**.

31.1 UART I/O Pin Configuration

The RX input pin is selected with the UxRPPS register. The TX output pin is selected with each pin's RxyPPS register. When the TRIS control for the pin corresponding to the TX output is cleared, then the UART will maintain control and the logic level on the TX pin. Changing the TXPOL bit in UxCON2 will immediately change the TX pin logic level regardless of the value of EN or TXEN.

31.2 UART Asynchronous Modes

The UART has five asynchronous modes:

- 7-bit
- 8-bit
- 8-bit with even parity in the 9th bit
- 8-bit with odd parity in the 9th bit
- 8-bit with address indicator in the 9th bit

The UART transmits and receives data using the standard Non-Return-to-Zero (NRZ) format. NRZ is implemented with two levels: a VOH mark state, which represents a '1' data bit, and a VOL space state, which represents a '0' data bit. NRZ refers to the fact that consecutively transmitted data bits of the same value stay at the output level of that bit without returning to a neutral level between each bit transmission. An NRZ transmission port idles in the Mark state. Each character transmission consists of one Start bit followed by seven or eight data bits, one optional parity or address bit, and is always terminated by one or more Stop bits. The Start bit is always a space and the Stop bits are always marks. The most common data format is eight bits with no parity. Each transmitted bit persists for a period of 1/(Baud Rate). An on-chip dedicated 16-bit Baud Rate Generator is used to derive standard baud rate frequencies from the system oscillator. See **Section 31.17 "UART Baud Rate Generator (BRG)"** for more information.

In all the asynchronous modes, the UART transmits and receives the LSb first. The UART's transmitter and receiver are functionally independent, but share the same data format and baud rate. Parity is supported by the hardware by even and odd parity modes.

31.2.1 UART ASYNCHRONOUS TRANSMITTER

The UART transmitter block diagram is shown in Figure 31-1. The heart of the transmitter is the serial Transmit Shift Register (TSR), which is not directly accessible by software. The TSR obtains its data from the transmit buffer, which is the UxTXB register.

31.17.1 AUTO-BAUD DETECT

The UART module supports automatic detection and calibration of the baud rate in the 8-bit asynchronous and LIN modes. However, setting ABDEN to start auto-baud detection is neither necessary, nor possible in LIN mode because that mode supports auto-baud detection automatically at the beginning of every data packet. Enabling auto-baud detect with the ABDEN bit applies to the asynchronous modes only.

Note:	In DALI Mode, ABDEN is ignored. The baud rate needs to be manually set to 1200 using the BRG registers.

When Auto-Baud Detect (ABD) is active, the clock to the BRG is reversed. Rather than the BRG clocking the incoming RX signal, the RX signal is timing the BRG. The Baud Rate Generator is used to time the period of a received 55h (ASCII “U”), which is the Sync character for the LIN bus. The unique feature of this character is that it has five falling edges, including the Start bit edge, five rising edges including the Stop bit edge.

In 8-bit Asynchronous mode, setting the ABDEN bit in the UxCON0 register enables the auto-baud calibration sequence. The first falling edge of the RX input after ABDEN is set will start the auto-baud calibration sequence. While the ABD sequence takes place, the UART state machine is held in idle. On the first falling edge of the receive line, the UxBRG begins counting up using the BRG counter clock as shown in Figure 31-12. The fifth falling edge will occur on the RX pin at the beginning of the bit 7 period. At that time, an accumulated value totaling the proper BRG period is left in the UxBRGH, UxBRGL register pair, the ABDEN bit is automatically cleared and the ABDIF interrupt flag is set. ABDIF must be cleared by software.

RXIDL indicates that the sync input is active. RXIDL will go low on the first falling edge and go high on the fifth rising edge.

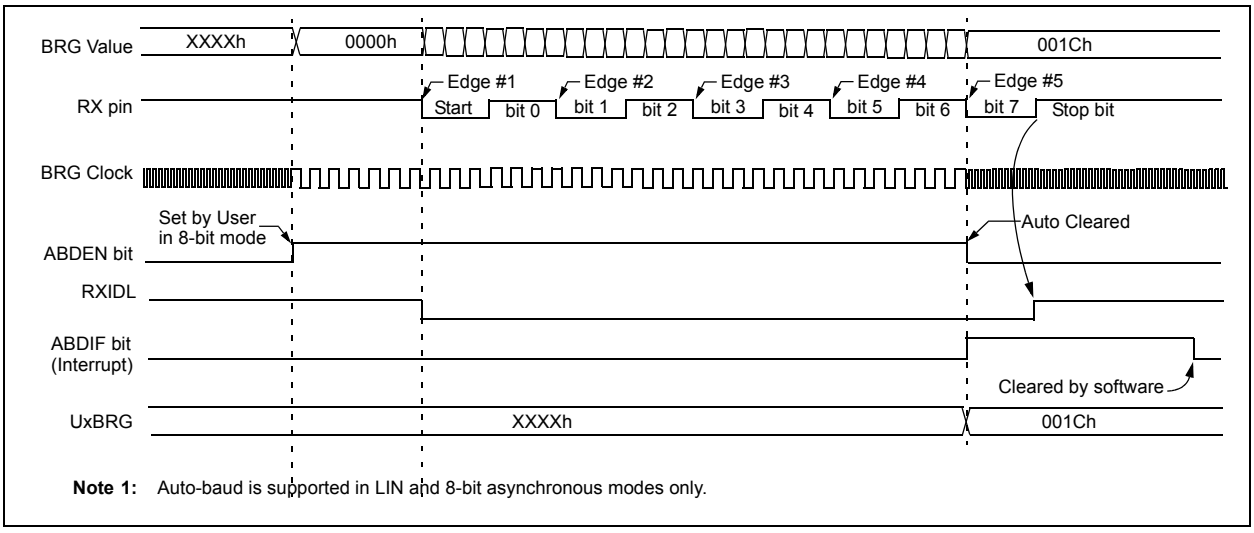
The BRG auto-baud clock is determined by the BRGS bit as shown in Table 31-2. During ABD, the internal BRG register is used as a 16-bit counter. However, the UxBRGH and UxBRGL registers retain the previous BRG value until the auto-baud process is successfully completed. While calibrating the baud rate period, the internal BRG register is clocked at 1/8th the BRG base clock rate. The resulting byte measurement is the average bit time when clocked at full speed and is transferred to the UxBRGH and UxBRGL registers when complete.

Note 1:	If the WUE bit is set with the ABDEN bit, auto-baud detection will occur on the byte following the Break character (see **Section 31.17.3 “Auto-Wake-up on Break”**).
2:	It is up to the user to determine that the incoming character baud rate is within the range of the selected BRG clock source. Some combinations of oscillator frequency and UART baud rates are not possible.

TABLE 31-2: BRG COUNTER CLOCK RATES

BRGS	BRG Base Clock	BRG ABD Clock
1	FOSC/4	FOSC/32
0	FOSC/16	FOSC/128

FIGURE 31-12: AUTOMATIC BAUD RATE CALIBRATION



Note 1: Auto-baud is supported in LIN and 8-bit asynchronous modes only.

39.2 HLVD Setup

To set up the HLVD module:

1. Select the desired HLVD trip point by writing the value to the SEL<3:0> bits of the HLVDCON1 register.
2. Depending on the application to detect high-voltage peaks or low-voltage drops or both, set the INTH or INTL bit appropriately.
3. Enable the HLVD module by setting the EN bit.
4. Clear the HLVD interrupt flag (PIR2 register), which may have been set from a previous interrupt.
5. If interrupts are desired, enable the HLVD interrupt by setting the HLVDIE in the PIE2 register and GIE bits.

   An interrupt will not be generated until the RDY bit is set.

Note:	Before changing any module settings (INTH, INTL, SEL<3:0>), first disable the module (EN = 0), make the changes and re-enable the module. This prevents the generation of false HLVD events.

39.3 Current Consumption

When the module is enabled, the HLVD comparator and voltage divider are enabled and consume static current. The total current consumption, when enabled, is specified in electrical specification Parameter **D206** (Table 44-4).

Depending on the application, the HLVD module does not need to operate constantly. To reduce current requirements, the HLVD circuitry may only need to be enabled for short periods where the voltage is checked. After such a check, the module could be disabled.

39.4 HLVD Start-up Time

The internal reference voltage of the HLVD module, specified in electrical specification (Table 44-19), may be used by other internal circuitry, such as the programmable Brown-out Reset. If the HLVD or other circuits using the voltage reference are disabled to lower the device's current consumption, the reference voltage circuit will require time to become stable before a low or high-voltage condition can be reliably detected. This start-up time, TFVRST, is an interval that is independent of device clock speed. It is specified in electrical specification (Table 44-19).

The HLVD interrupt flag is not enabled until TFVRST has expired and a stable reference voltage is reached. For this reason, brief excursions beyond the set point may not be detected during this interval (see Figure 39-2 or Figure 39-3).

40.0 IN-CIRCUIT SERIAL PROGRAMMING™ (ICSP™)

ICSP™ programming allows customers to manufacture circuit boards with unprogrammed devices. Programming can be done after the assembly process, allowing the device to be programmed with the most recent firmware or a custom firmware. Five pins are needed for ICSP™ programming:

- ICSPCLK
- ICSPDAT
- $\overline{\text{MCLR}}$/VPP
- VDD
- VSS

In Program/Verify mode the program memory, User IDs and the Configuration Words are programmed through serial communications. The ICSPDAT pin is a bidirectional I/O used for transferring the serial data and the ICSPCLK pin is the clock input. For more information on ICSP™ refer to the **"**PIC18F26/27/45/46/47/55/56/57K42 *Memory Programming Specification***"** (DS40001886).

40.1 High-Voltage Programming Entry Mode

The device is placed into High-Voltage Programming Entry mode by holding the ICSPCLK and ICSPDAT pins low then raising the voltage on $\overline{\text{MCLR}}$/VPP to VIHH.

40.2 Low-Voltage Programming Entry Mode

The Low-Voltage Programming Entry mode allows the PIC® Flash MCUs to be programmed using VDD only, without high voltage. When the LVP bit of Configuration Words is set to '1', the low-voltage ICSP™ programming entry is enabled. To disable the Low-Voltage ICSP mode, the LVP bit must be programmed to '0'.

Entry into the Low-Voltage Programming Entry mode requires the following steps:

1. $\overline{\text{MCLR}}$ is brought to VIL.
2. A 32-bit key sequence is presented on ICSPDAT, while clocking ICSPCLK.

Once the key sequence is complete, $\overline{\text{MCLR}}$ must be held at VIL for as long as Program/Verify mode is to be maintained.

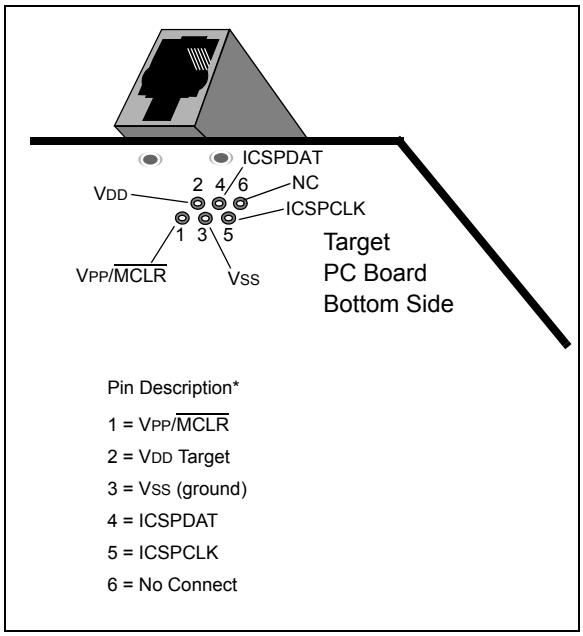
If low-voltage programming is enabled (LVP = 1), the $\overline{\text{MCLR}}$ Reset function is automatically enabled and cannot be disabled. See **Section 6.5 "MCLR"** for more information.

The LVP bit can only be reprogrammed to '0' by using the High-Voltage Programming mode.

40.3 Common Programming Interfaces

Connection to a target device is typically done through an ICSP™ header. A commonly found connector on development tools is the RJ-11 in the 6P6C (6-pin, 6-connector) configuration. See Figure 40-1.

FIGURE 40-1: ICD RJ-11 STYLE CONNECTOR INTERFACE

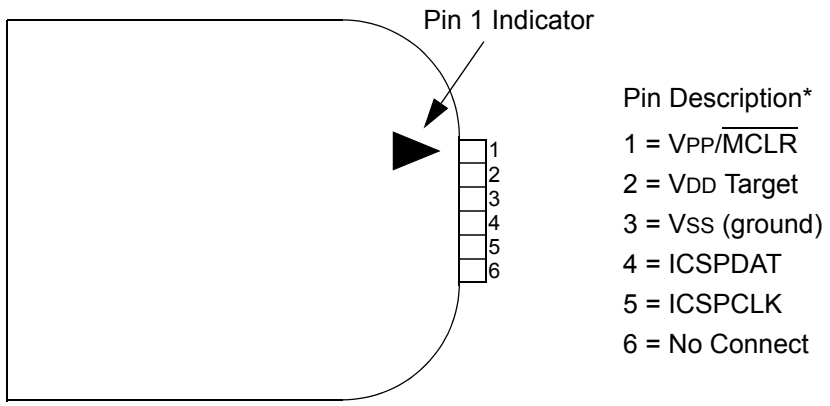


Another connector often found in use with the PICkit™ programmers is a standard 6-pin header with 0.1 inch spacing. Refer to Figure 40-2.

For additional interface recommendations, refer to your specific device programmer manual prior to PCB design.

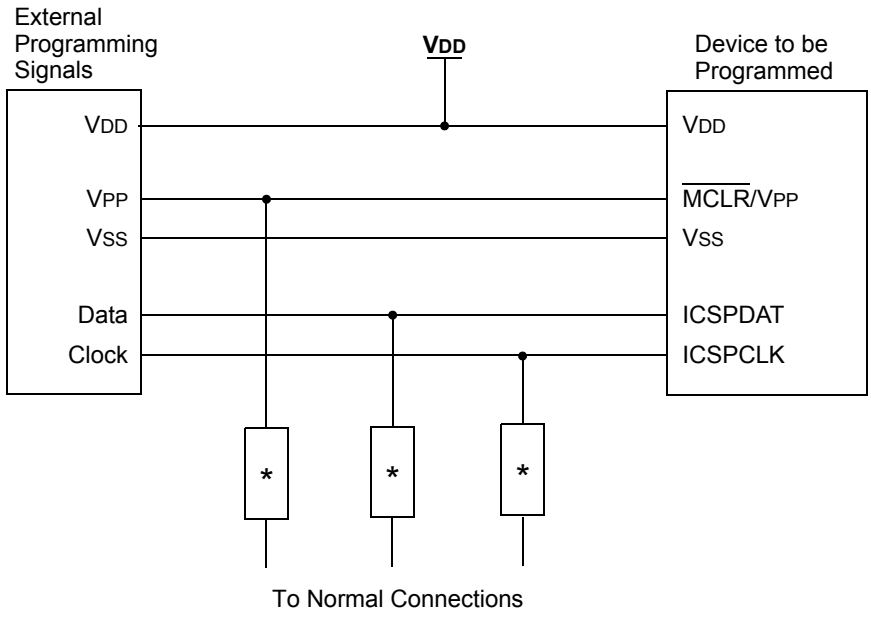
It is recommended that isolation devices be used to separate the programming pins from other circuitry. The type of isolation is highly dependent on the specific application and may include devices such as resistors, diodes, or even jumpers. See Figure 40-3 for more information.

FIGURE 40-2: PICkit™ PROGRAMMER STYLE CONNECTOR INTERFACE



* The 6-pin header (0.100" spacing) accepts 0.025" square pins.

FIGURE 40-3: TYPICAL CONNECTION FOR ICSP™ PROGRAMMING



* Isolation devices (as required).

ANDWF **AND W with f**

Syntax: ANDWF f {,d {,a}}

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (W) .AND. (f) → dest

Status Affected: N, Z

Encoding:

0001	01da	ffff	ffff

Description: The contents of W are AND'ed with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).
If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.
If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever f ≤ 95 (5Fh). See **Section 41.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode"** for details.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `ANDWF REG, 0, 0`

Before Instruction
W = 17h
REG = C2h
After Instruction
W = 02h
REG = C2h

BC **Branch if Carry**

Syntax: BC n

Operands: $-128 \le n \le 127$

Operation: if CARRY bit is '1'
(PC) + 2 + 2n → PC

Status Affected: None

Encoding:

1110	0010	nnnn	nnnn

Description: If the CARRY bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a 2-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BC   5
```
Before Instruction
PC = address (HERE)
After Instruction
If CARRY = 1;
PC = address (HERE + 12)
If CARRY = 0;
PC = address (HERE + 2)

SUBULNK Subtract Literal from FSR2 and Return

Syntax: SUBULNK k

Operands: $0 \le k \le 63$

Operation: FSR2 – k → FSR2

(TOS) → PC

Status Affected: None

Encoding:

1110	1001	11kk	kkkk

Description: The 6-bit literal 'k' is subtracted from the contents of the FSR2. A RETURN is then executed by loading the PC with the TOS. The instruction takes two cycles to execute; a NOP is performed during the second cycle.
This may be thought of as a special case of the SUBFSR instruction, where f = 3 (binary '11'); it operates only on FSR2.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination
No Operation	No Operation	No Operation	No Operation

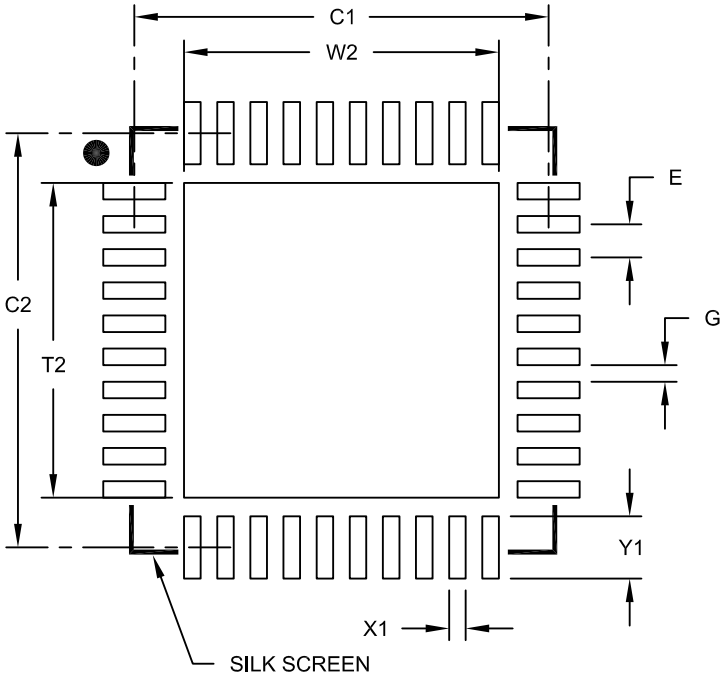
Example: SUBULNK 23h

Before Instruction
FSR2 = 03FFh
PC = 0100h

After Instruction
FSR2 = 03DCh
PC = (TOS)

40-Lead Plastic Ultra Thin Quad Flat, No Lead Package (MV) - 5x5 mm Body [UQFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Optional Center Pad Width	W2			3.80
Optional Center Pad Length	T2			3.80
Contact Pad Spacing	C1		5.00	
Contact Pad Spacing	C2		5.00	
Contact Pad Width (X40)	X1			0.20
Contact Pad Length (X40)	Y1			0.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2156B